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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Not For New Designs
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	100MHz
Connectivity	CANbus, EBI/EMI, I ² C, LINbus, SCI, SPI, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	72
Program Memory Size	512KB (512K x 8)
Program Memory Type	FLASH
EEPROM Size	32K x 8
RAM Size	48K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 12x10b, 8x12b; D/A 2x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	120-LQFP
Supplier Device Package	120-LQFP (16x16)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f563tebdfa-v0

Table 1.1 Outline of Specifications (5/7)

Classification	Module/Function	Description
Communication function	I ² C bus interfaces (RIIC)	2 channels - Communication formats - I²C bus format/SMBus format - Supports the multi-master - Max. transfer rate: 400 kbps
	CAN module (CAN)	1 channels - Compliance with the ISO11898-1 specification (standard frame and extended frame) 32 mailboxes per channel
	Serial peripheral interfaces (RSPI)	2 channels - RSPI transfer facility - Using the MOSI (master out, slave in), MISO (master in, slave out), SSL (slave select), and RSPCK (RSPI clock) signals enables serial transfer through SPI operation (four lines) or clock-synchronous operation (three lines) - Capable of handling serial transfer as a master or slave - Data formats - Switching between MSB first and LSB first - The number of bits in each transfer can be changed to any number of bits from 8 to 16, or to 20, 24, or 32 bits. 128-bit buffers for transmission and reception - Up to four frames can be transmitted or received in a single transfer operation (with each frame having up to 32 bits) - Buffered structure - Double buffers for both transmission and reception - Max. transfer rate - In master mode: [144-, 120-, 112- and 100-pin versions] 25 Mbps [64- and 48-pin versions] 12.5 Mbps - In slave mode: 6.25 Mbps
12-bit A/D converter (S12ADB) [144-, 120-, 112- and 100-pin versions]		12 bits (4 channels x 2 unit) 12-bit resolution - Conversion time 1.0 μs per channel (clock for S12ADB, PCLKD (A/D conversion clock ADCLK) = 50 MHz, AVCC0 = 4.0 to 5.5 V) 2.0 μs per channel (clock for S12ADB, PCLKD (A/D conversion clock ADCLK) = 25 MHz, AVCC0 = 3.0 to 3.6 V) - Operating modes - Scan mode (single-cycle scan mode/continuous scan mode/group scan mode) - Group A priority control (only for the group scan mode) - Sample-and-hold function - A common sample-and-hold circuit for units is included. - Additionally, sample-and-hold circuit for each unit is included. (three channels per unit) - Self-diagnostic function - The self-diagnostic function internally generates three analog input voltages (VREFL0, VREFH0 x 1/2, VREFH0). - Double trigger mode (duplication of A/D converted data) - Input signal amplification function using programmable gain amplifier (three channels per unit) - Amplification factors: 2.0 times, 2.5 times, 3.077 times, 3.636 times, 4.0 times, 4.444 times, 5.0 times, 5.714 times, 6.667 times, 10.0 times, 13.333 times (total of 11 steps) - Three ways to start A/D conversion - Conversion can be started by software, a conversion start trigger from a timer (MTU3 or GPT), or an external trigger signal. - Window comparators (three channels per unit)

Table 1.2 Comparison of Functions for Different Packages

Functions			RX63T Group						
Package			144 Pins	120 Pins	112 Pins	100 Pins	64 Pins	48 Pins	
External bus			16 bits				—		
External address space			1 Mbyte × 4 areas				—		
DMA	DMA controller (DMACA)		Ch. 0 to 3						
	Data transfer controller (DTCa)		Supported						
Interrupt controller (ICUb)	NMI pin		Supported						
	IRQ pin		Supported (x 8)				Supported (x 6)		
Timers	Multi-function timer pulse unit 3 (MTU3)* ¹		Ch. 0 to 7						
	General PWM timer (GPT)* ¹	Generation of delays in PWM, not supported	Ch. 0 to 7				Ch. 0 to 3		
		Generation of delays in PWM, supported	Ch. 0 to 3				—		
	Port output enable 3 (POE3)		Supported (POE pins × 6)			Supported (POE pins × 5)	Supported (POE pins × 4)		
	Compare match timer (CMT)		Ch. 0 to 3						
	Watchdog timer (WDTA)		Supported						
	Independent watchdog timer (IWDTa)		Supported						
	Communication function	USB2.0 host/function module (USBa)		Ch. 0		—			
Serial communications interfaces (SClc)		Ch. 0 to 3			Ch. 0 to 2	Ch. 0, 1			
Serial communications interfaces (SCld)		Ch. 12							
I ² C bus interfaces (RIIC)		Ch. 0, 1		Ch. 0					
Serial peripheral interfaces (RSPI)		Ch. 0, 1				Ch. 0			
CAN module (CAN) (as an optional function)* ¹		Ch. 0				—			
12-bit A/D converter (S12ADB)			4 channels × 2 units				8 channels × 1 unit (AN000 to 007)	8 channels × 1 unit (AN000 to 004, 007)	
			Three-channel simultaneous sampling function				1 unit		
			Programmable gain amplifier				—		
			Window comparator				3 channels × 1 unit		
10-bit A/D converter (ADA)			20 channels	12 channels			—		
D/A converter (DAa)			Ch. 0, 1				—		
Clock Frequency Accuracy Measurement Circuit			Supported						
Digital power supply controller (DPC)* ²			Supported				Not supported		

Note 1. For the MTU3 and GPT, the number of pins will differ with the package. See the list of pins and pin functions for details.

In addition, the CAN module is an optional function. For details, see Table 1.3.

Note 2. Not provided for the product ID code O.

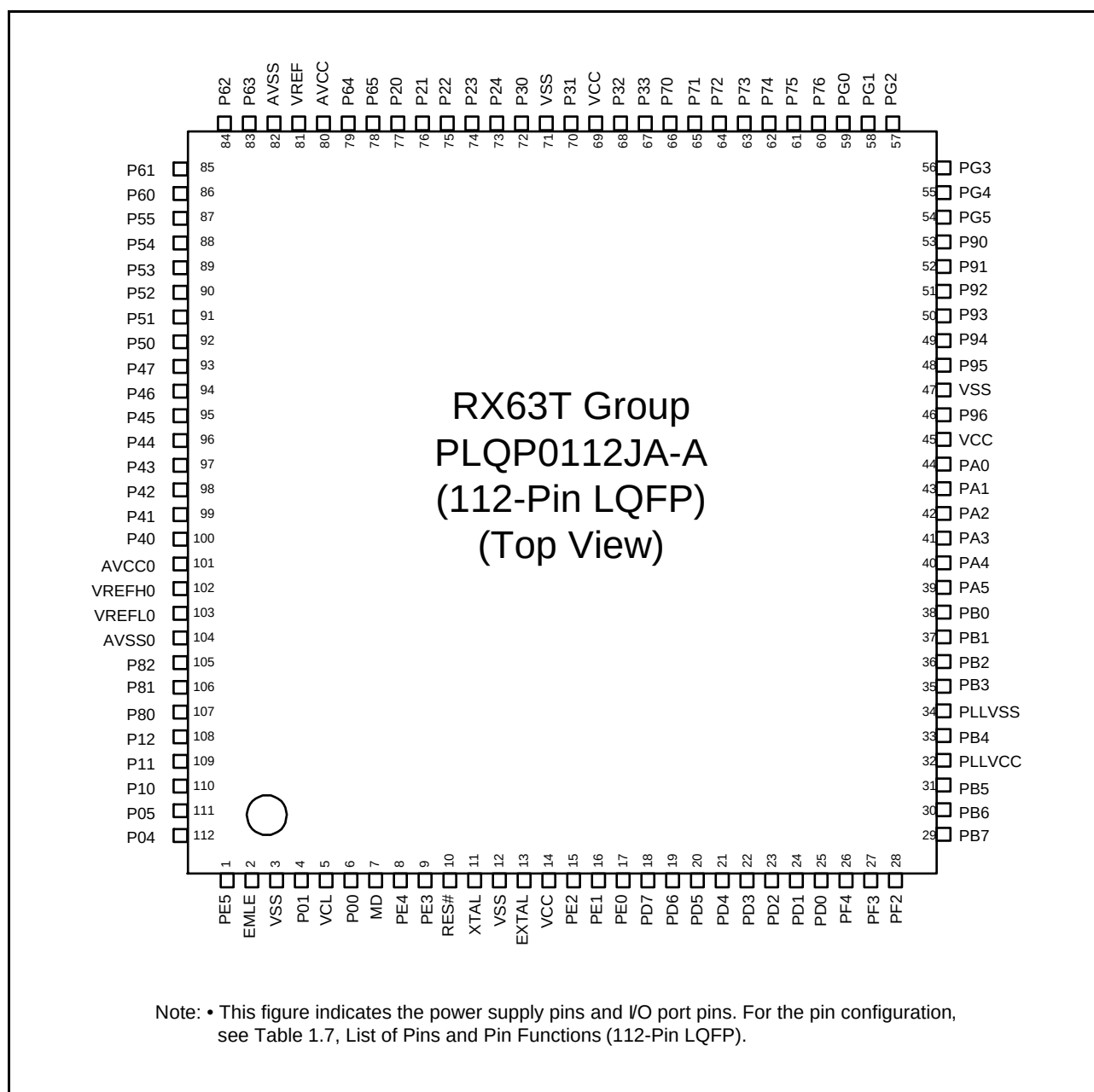


Figure 1.5 Pin Assignment (112-Pin LQFP)

Table 1.5 List of Pins and Pin Functions (144-Pin LQFP) (1/4)

Pin Number 144-Pin LQFP	Power Supply Clock System Control	I/O Port	Bus	Timer (MTU3, GPT, POE3, CAC)	Communications (SCIC, SCID, RSPI, RIIC, CAN, USB)	Interrupt	S12ADB, AD, DA
1	VCC_USB						
2		PE5	BCLK		USB0_VBUS	IRQ0	
3	EMLE						
4	TRSYNC	P03			RXD2/SMISO2/SSCL2	IRQ7	
5	TRDATA3	P02			TXD2/SMOSI2/SSDA2		
6	VSS						
7		P01	RD#		CTS0#/RTS0#/SS0#/ USB0_DRPD		
8	VCL						
9		P00	CS1#	CACREF			
10	MD/FINED						
11		PE4	A10	POE10#/MTCLKC		IRQ1	
12		PE3	A11	POE11#/MTCLKD		IRQ2-DS	
13	TRDATA2	P14			SCK2		
14	VCC						
15		P13			CTS2#/RTS2#/SS2#/ USB0_VBUSEN		
16	RES#						
17	XTAL						
18	VSS						
19	EXTAL						
20	VCC						
21		PE2		POE10#		NMI	
22		PE1	WR0#/WR#		CTS12#/RTS12#/ SS12#/SSLA3/SSLB3/ USB0_OVRCURA		
23		PE0	WR1#/BC1#/ WAIT#		SSLA2/SSLB2/CRX1/ USB0_OVRCURB	IRQ7	
24		PD7		GTIOC0A	CTS0#/RTS0#/SS0#/ SSLA1/SSLB1/CTX1		
25		PD6		GTIOC0B	SSLA0/SSLB0		
26		PD5		GTIOC1A	RXD1/SMISO1/SSCL1	IRQ6	
27	VSS						
28		PD4		GTIOC1B	SCK1		
29		PD3		GTIOC2A	TXD1/SMOSI1/SSDA1		
30		PD2	CS2#	GTIOC2B	MOSIA/MOSIB/ USB0_ID		
31		PD1	CS0#	GTIOC3A	MISOA/MISOB/ USB0_EXICEN		
32		PD0	A12	GTIOC3B	RSPCKA/RSPCKB		
33		PF4	CS3#				
34		PF3			TXD1/SMOSI1/SSDA1		
35		PF2	CS1#		RXD1/SMISO1/SSCL1	IRQ5	
36	TRST#	PF1					
37	TMS	PF0					
38		PB7	A19		SCK12		

Table 1.7 List of Pins and Pin Functions (112-Pin LQFP) (2/4)

Pin Number 112-Pin LQFP	Power Supply Clock System Control	I/O Port	Bus	Timer (MTU3, GPT, POE3, CAC)	Communications (SCIC, SCID, RSPI, RIIC, CAN)	Interrupt	S12ADB, AD, DA
38		PB0	A14	MTIOC0D	MOSIA/MOSIB		
39		PA5		MTIOC1A	RXD0/SMISO0/ SSCL0/ MISOA/MISOB		ADTRG1#
40		PA4		MTIOC1B	TXD0/SMOSI0/ SSDA0/RSPCKA/ RSPCKB		ADTRG0#
41		PA3		MTIOC2A	SCK0/SSLA0/SSLB0		
42		PA2		MTIOC2B	RXD2/SMISO2/ SSCL2/ SSLA1/SSLB1		
43		PA1		MTIOC6A	TXD2/SMOSI2/ SSDA2/SSLA2/SSLB2		
44		PA0		MTIOC6C	SCK2/SSLA3/SSLB3		
45	VCC						
46		P96	A13	POE4#	RXD1/SMISO1/SSCL1	IRQ4-DS	
47	VSS						
48		P95		MTIOC6B/ GTIOC4A	TXD1/SMOSI1/SSDA1		
49		P94		MTIOC7A/ GTIOC5A	CTS1#/RTS1#/SS1#		
50		P93		MTIOC7B/ GTIOC6A	CTS2#/RTS2#/SS2#		
51		P92		MTIOC6D/GTIOC4B			
52		P91		MTIOC7C/GTIOC5B			
53		P90		MTIOC7D/GTIOC6B			
54	TRCLK	PG5		POE12#	SCK3		ADTRG#
55	TRDATA3	PG4		GTIOC6B	RXD3/SMISO3/SSCL3	IRQ6	
56	TRDATA2	PG3		GTIOC6A	TXD3/SMOSI3/SSDA3		
57	TRDATA1	PG2			SCK2	IRQ2	
58	TRDATA0	PG1		GTIOC7B	RXD2/SMISO2/SSCL2	IRQ1	
59	TRSYNC	PG0		GTIOC7A	TXD2/SMOSI2/SSDA2	IRQ0	
60		P76	D0/[A0/D0]	MTIOC4D/GTIOC2B			
61		P75	D1/[A1/D1]	MTIOC4C/GTIOC1B			
62		P74	D2/[A2/D2]	MTIOC3D/GTIOC0B			
63		P73	D3/[A3/D3]	MTIOC4B/GTIOC2A			
64		P72	D4/[A4/D4]	MTIOC4A/GTIOC1A			
65		P71	D5/[A5/D5]	MTIOC3B/GTIOC0A			
66		P70	D6/[A6/D6]	POE0#	CTS1#/RTS1#/SS1#	IRQ5-DS	
67		P33	D7/[A7/D7]	MTIOC3A/MTCLKA	SSLA3/SSLB3		
68		P32	D8/[A8/D8]	MTIOC3C/MTCLKB	SSLA2/SSLB2		
69	VCC						
70		P31	D9/[A9/D9]	MTIOC0A/MTCLKC	SSLA1/SSLB1		
71	VSS						
72		P30	D10/[A10/ D10]	MTIOC0B/MTCLKD	SCK0/SSLA0/SSLB0		
73		P24	D11/[A11/D11]		CTS0#/RTS0#/SS0#/ RSPCKA/RSPCKB	IRQ4	

2. CPU

The RX CPU has sixteen general-purpose registers, nine control registers, and one accumulator used for DSP instructions.

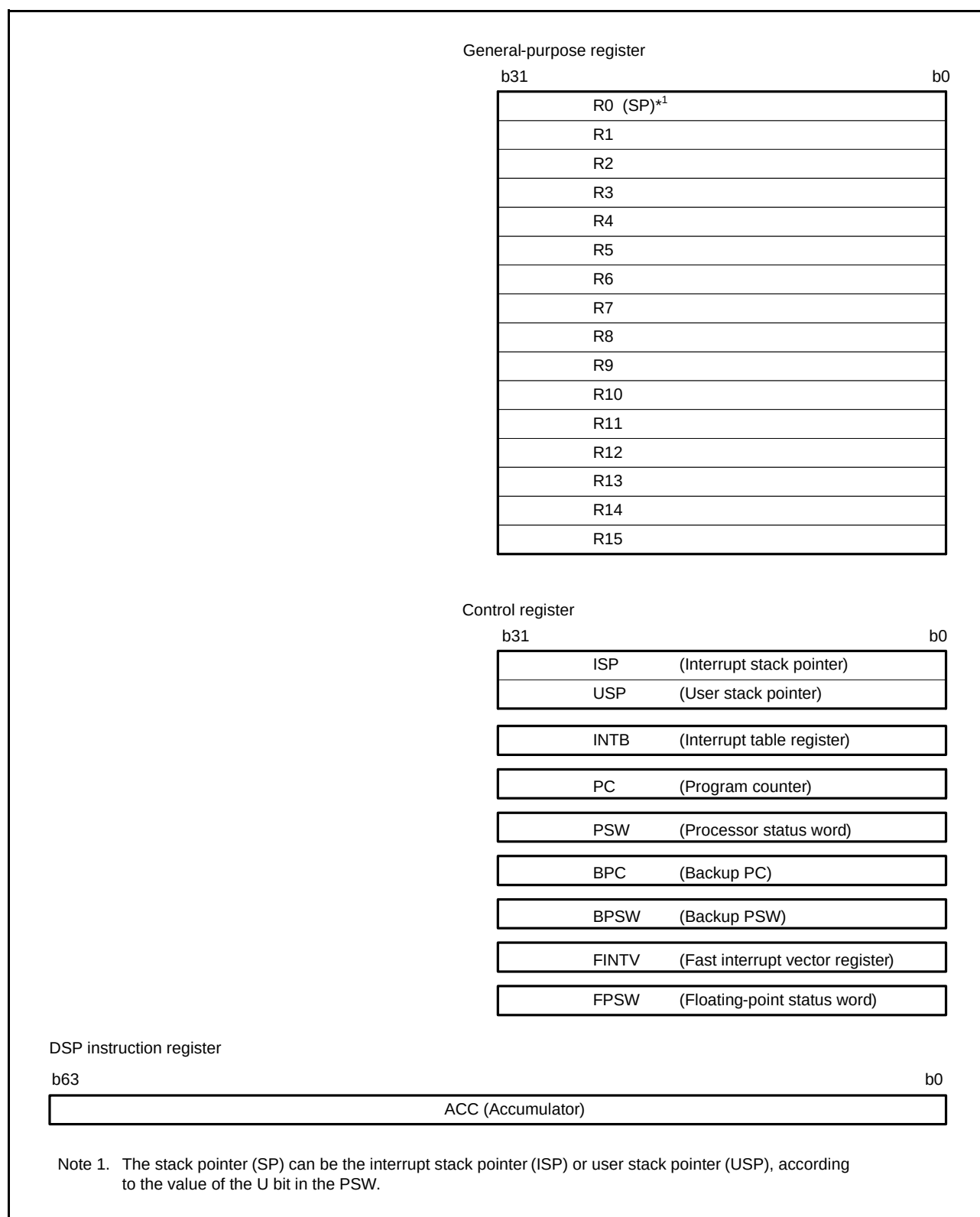


Figure 2.1 Register Set of the CPU

Table 4.1 List of I/O Registers (Address Order) (20/48)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Module Name	Remarks
						ICLK ≥ PCLK	ICLK < PCLK		
0008 9873h	AD	A/D Sampling State Register 1	ADSSTR1	8	8	2, 3 PCLKB	2 ICLK	AD	Not present in versions with 64 or 48 pins.
0008 9874h	AD	A/D Sampling State Register 2	ADSSTR2	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 9875h	AD	A/D Sampling State Register 3	ADSSTR3	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 9876h	AD	A/D Sampling State Register 4	ADSSTR4	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 9877h	AD	A/D Sampling State Register 5	ADSSTR5	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 9878h	AD	A/D Sampling State Register 6	ADSSTR6	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 9879h	AD	A/D Sampling State Register 7	ADSSTR7	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 987Dh	AD	Digital Power Supply Control Circuit Output Register	ADDPCONR	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64, or 48 pins.
0008 A000h	SCI0	Serial Mode Register	SMR	8	8	2, 3 PCLKB	2 ICLK	SCIc, SCId	
0008 A001h	SCI0	Bit Rate Register	BRR	8	8	2, 3 PCLKB	2 ICLK		
0008 A002h	SCI0	Serial Control Register	SCR	8	8	2, 3 PCLKB	2 ICLK		
0008 A003h	SCI0	Transmit Data Register	TDR	8	8	2, 3 PCLKB	2 ICLK		
0008 A004h	SCI0	Serial Status Register	SSR	8	8	2, 3 PCLKB	2 ICLK		
0008 A005h	SCI0	Receive Data Register	RDR	8	8	2, 3 PCLKB	2 ICLK		
0008 A006h	SCI0	Smart Card Mode Register	SCMR	8	8	2, 3 PCLKB	2 ICLK		
0008 A007h	SCI0	Serial Extended Mode Register	SEMR	8	8	2, 3 PCLKB	2 ICLK		
0008 A008h	SCI0	Noise Filter Setting Register	SNFR	8	8	2, 3 PCLKB	2 ICLK		
0008 A009h	SCI0	I ² C Mode Register 1	SIMR1	8	8	2, 3 PCLKB	2 ICLK		
0008 A00Ah	SCI0	I ² C Mode Register 2	SIMR2	8	8	2, 3 PCLKB	2 ICLK		
0008 A00Bh	SCI0	I ² C Mode Register 3	SIMR3	8	8	2, 3 PCLKB	2 ICLK		
0008 A00Ch	SCI0	I ² C Status Register	SISR	8	8	2, 3 PCLKB	2 ICLK		
0008 A00Dh	SCI0	SPI Mode Register	SPMR	8	8	2, 3 PCLKB	2 ICLK		
0008 A020h	SCI1	Serial Mode Register	SMR	8	8	2, 3 PCLKB	2 ICLK		
0008 A021h	SCI1	Bit Rate Register	BRR	8	8	2, 3 PCLKB	2 ICLK		
0008 A022h	SCI1	Serial Control Register	SCR	8	8	2, 3 PCLKB	2 ICLK		
0008 A023h	SCI1	Transmit Data Register	TDR	8	8	2, 3 PCLKB	2 ICLK		
0008 A024h	SCI1	Serial Status Register	SSR	8	8	2, 3 PCLKB	2 ICLK		
0008 A025h	SCI1	Receive Data Register	RDR	8	8	2, 3 PCLKB	2 ICLK		
0008 A026h	SCI1	Smart Card Mode Register	SCMR	8	8	2, 3 PCLKB	2 ICLK		
0008 A027h	SCI1	Serial Extended Mode Register	SEMR	8	8	2, 3 PCLKB	2 ICLK		
0008 A028h	SCI1	Noise Filter Setting Register	SNFR	8	8	2, 3 PCLKB	2 ICLK		
0008 A029h	SCI1	I ² C Mode Register 1	SIMR1	8	8	2, 3 PCLKB	2 ICLK		
0008 A02Ah	SCI1	I ² C Mode Register 2	SIMR2	8	8	2, 3 PCLKB	2 ICLK		
0008 A02Bh	SCI1	I ² C Mode Register 3	SIMR3	8	8	2, 3 PCLKB	2 ICLK		
0008 A02Ch	SCI1	I ² C Status Register	SISR	8	8	2, 3 PCLKB	2 ICLK		
0008 A02Dh	SCI1	SPI Mode Register	SPMR	8	8	2, 3 PCLKB	2 ICLK		
0008 A040h	SCI2	Serial Mode Register	SMR	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 A041h	SCI2	Bit Rate Register	BRR	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 A042h	SCI2	Serial Control Register	SCR	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 A043h	SCI2	Transmit Data Register	TDR	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 A044h	SCI2	Serial Status Register	SSR	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 A045h	SCI2	Receive Data Register	RDR	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 A046h	SCI2	Smart Card Mode Register	SCMR	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.

Table 4.1 List of I/O Registers (Address Order) (24/48)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Module Name	Remarks
						ICLK ≥ PCLK	ICLK < PCLK		
0008 C086h	PORT3	Open Drain Control Register 0	ODR0	8	8	2, 3 PCLKB	2 ICLK	I/O Ports	Not present in versions with 144, 120, 112, or 100 pins.
0008 C087h	PORT3	Open Drain Control Register 1	ODR1	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 120, 112, 100, 64 or 48 pins.
0008 C090h	PORT8	Open Drain Control Register 0	ODR0	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 C092h	PORT9	Open Drain Control Register 0	ODR0	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 144, 120, 112, 100 or 48 pins.
0008 C093h	PORT9	Open Drain Control Register 1	ODR1	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 48 pins.
0008 C094h	PORTA	Open Drain Control Register 0	ODR0	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 C095h	PORTA	Open Drain Control Register 1	ODR1	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 C096h	PORTB	Open Drain Control Register 0	ODR0	8	8	2, 3 PCLKB	2 ICLK		
0008 C097h	PORTB	Open Drain Control Register 1	ODR1	8	8	2, 3 PCLKB	2 ICLK		
0008 C09Ah	PORTD	Open Drain Control Register 0	ODR0	8	8	2, 3 PCLKB	2 ICLK		
0008 C09Bh	PORTD	Open Drain Control Register 1	ODR1	8	8	2, 3 PCLKB	2 ICLK		
0008 C09Eh	PORTF	Open Drain Control Register 0	ODR0	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 100, 64, or 48 pins.
0008 C0A0h	PORTG	Open Drain Control Register 0	ODR0	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 100, 64, or 48 pins.
0008 C0A1h	PORTG	Open Drain Control Register 1	ODR1	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 100, 64, or 48 pins.
0008 C0F2h	PORT	Driving Ability Control Register 1	DSCR1	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 C0F3h	PORT	Driving Ability Control Register 2	DSCR2	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 C100h	MPC	CS Output Enable Register	PFCSE	8	8	2, 3 PCLKB	2 ICLK	MPC	Not present in versions with 64 or 48 pins.
0008 C102h	MPC	CS Output Pin Select Register 0	PFCSS0	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 C104h	MPC	Address Output Enable Register 0	PFAOE0	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 C105h	MPC	Address Output Enable Register 1	PFAOE1	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 C106h	MPC	External Bus Control Register 0	PFBCR0	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 C107h	MPC	External Bus Control Register 1	PFBCR1	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 64 or 48 pins.
0008 C114h	MPC	USB0 Control Register	PFUSB0	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 112, 100, 64, or 48 pins.
0008 C11Fh	MPC	Write-Protect Register	PWPR	8	8	2, 3 PCLKB	2 ICLK		
0008 C140h	MPC	P00 Pin Function Control Register	P00PFS	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 48 pins.
0008 C141h	MPC	P01 Pin Function Control Register	P01PFS	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 48 pins.
0008 C142h	MPC	P02 Pin Function Control Register	P02PFS	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 120, 112, 100, 64, or 48 pins.
0008 C143h	MPC	P03 Pin Function Control Register	P03PFS	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 120, 112, 100, 64, or 48 pins.
0008 C148h	MPC	P10 Pin Function Control Register	P10PFS	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 48 pins.
0008 C149h	MPC	P11 Pin Function Control Register	P11PFS	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 48 pins.
0008 C14Ah	MPC	P12 Pin Function Control Register	P12PFS	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 100, 64, or 48 pins.
0008 C14Bh	MPC	P13 Pin Function Control Register	P13PFS	8	8	2, 3 PCLKB	2 ICLK		Not present in versions with 112, 100, 64, or 48 pins.

Table 4.1 List of I/O Registers (Address Order) (39/48)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Module Name	Remarks
						ICLK $\geq$ PCLK	ICLK $<$ PCLK		
000C 21A6h	GPT1	A/D Converter Start Request Timing Buffer Register A	GTADTBRA	16	16, 32	2 to 5 PCLKA	2, 3 ICLK	GPT	
000C 21A8h	GPT1	A/D Converter Start Request Timing Double-Buffer Register A	GTADTBRA	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 21ACh	GPT1	A/D Converter Start Request Timing Register B	GTADTRB	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 21AEh	GPT1	A/D Converter Start Request Timing Buffer Register B	GTADTBRA	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 21B0h	GPT1	A/D Converter Start Request Timing Double-Buffer Register B	GTADTBRA	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 21B4h	GPT1	General PWM Timer Output Negate Control Register	GTONCR	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 21B6h	GPT1	General PWM Timer Dead Time Control Register	GTDTCR	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 21B8h	GPT1	General PWM Timer Dead Time Value Register U	GTDVU	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 21BAh	GPT1	General PWM Timer Dead Time Value Register D	GTDVD	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 21BCh	GPT1	General PWM Timer Dead Time Buffer Register U	GTDBU	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 21BEh	GPT1	General PWM Timer Dead Time Buffer Register D	GTDBD	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 21C0h	GPT1	General PWM Timer Output Protection Function Status Register	GTSOS	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 21C2h	GPT1	General PWM Timer Output Protection Function Temporary Release Register	GTSOTR	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 2200h	GPT2	General PWM Timer I/O Control Register	GTIOR	16	8, 16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 2202h	GPT2	General PWM Timer Interrupt Output Setting Register	GTINTAD	16	8, 16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 2204h	GPT2	General PWM Timer Control Register	GTCR	16	8, 16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 2206h	GPT2	General PWM Timer Buffer Enable Register	GTBER	16	8, 16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 2208h	GPT2	General PWM Timer Count Direction Register	GTUDC	16	8, 16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 220Ah	GPT2	General PWM Timer Interrupt and A/D Converter Start Request Skipping Setting Register	GTITC	16	8, 16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 220Ch	GPT2	General PWM Timer Status Register	GTST	16	8, 16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 220Eh	GPT2	General PWM Timer Counter	GTCNT	16	16	2 to 5 PCLKA	2, 3 ICLK		
000C 2210h	GPT2	General PWM Timer Compare Capture Register A	GTCCRA	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 2212h	GPT2	General PWM Timer Compare Capture Register B	GTCCRB	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 2214h	GPT2	General PWM Timer Compare Capture Register C	GTCCRC	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 2216h	GPT2	General PWM Timer Compare Capture Register D	GTCCRD	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 2218h	GPT2	General PWM Timer Compare Capture Register E	GTCCRE	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 221Ah	GPT2	General PWM Timer Compare Capture Register F	GTCCRF	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 221Ch	GPT2	General PWM Timer Cycle Setting Register	GTPR	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 221Eh	GPT2	General PWM Timer Cycle Setting Buffer Register	GTPBR	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 2220h	GPT2	General PWM Timer Cycle Setting Double-Buffer Register	GTPDBR	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 2224h	GPT2	A/D Converter Start Request Timing Register A	GTADTRA	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 2226h	GPT2	A/D Converter Start Request Timing Buffer Register A	GTADTBRA	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 2228h	GPT2	A/D Converter Start Request Timing Double-Buffer Register A	GTADTBRA	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 222Ch	GPT2	A/D Converter Start Request Timing Register B	GTADTRB	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		
000C 222Eh	GPT2	A/D Converter Start Request Timing Buffer Register B	GTADTBRA	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		

Table 4.1 List of I/O Registers (Address Order) (45/48)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Module Name	Remarks
						ICLK $\geq$ PCLK	ICLK < PCLK		
000C 2A24h	GPT6	A/D Converter Start Request Timing Register A	GTADTRA	16	16, 32	2 to 5 PCLKA	2, 3 ICLK	GPT	Not present in versions with 64 or 48 pins.
000C 2A26h	GPT6	A/D Converter Start Request Timing Buffer Register A	GTADTBRA	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2A28h	GPT6	A/D Converter Start Request Timing Double-Buffer Register A	GTADTDBRA	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2A2Ch	GPT6	A/D Converter Start Request Timing Register B	GTADTRB	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2A2Eh	GPT6	A/D Converter Start Request Timing Buffer Register B	GTADTBRA	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2A30h	GPT6	A/D Converter Start Request Timing Double-Buffer Register B	GTADTDBRA	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2A34h	GPT6	General PWM Timer Output Negate Control Register	GTONCR	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2A36h	GPT6	General PWM Timer Dead Time Control Register	GTDTCR	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2A38h	GPT6	General PWM Timer Dead Time Value Register U	GTDVU	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2A3Ah	GPT6	General PWM Timer Dead Time Value Register D	GTDVD	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2A3Ch	GPT6	General PWM Timer Dead Time Buffer Register U	GTDBU	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2A3Eh	GPT6	General PWM Timer Dead Time Buffer Register D	GTDBD	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2A40h	GPT6	General PWM Timer Output Protection Function Status Register	GTSOS	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2A42h	GPT6	General PWM Timer Output Protection Function Temporary Release Register	GTSOTR	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2A80h	GPT7	General PWM Timer I/O Control Register	GTIOR	16	8, 16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2A82h	GPT7	General PWM Timer Interrupt Output Setting Register	GTINTAD	16	8, 16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2A84h	GPT7	General PWM Timer Control Register	GTCR	16	8, 16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2A86h	GPT7	General PWM Timer Buffer Enable Register	GTBER	16	8, 16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2A88h	GPT7	General PWM Timer Count Direction Register	GTUDC	16	8, 16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2A8Ah	GPT7	General PWM Timer Interrupt and A/D Converter Start Request Skipping Setting Register	GTITC	16	8, 16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2A8Ch	GPT7	General PWM Timer Status Register	GTST	16	8, 16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2A8Eh	GPT7	General PWM Timer Counter	GTCNT	16	16	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2A90h	GPT7	General PWM Timer Compare Capture Register A	GTCCRA	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2A92h	GPT7	General PWM Timer Compare Capture Register B	GTCCRB	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2A94h	GPT7	General PWM Timer Compare Capture Register C	GTCCRC	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2A96h	GPT7	General PWM Timer Compare Capture Register D	GTCCRD	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2A98h	GPT7	General PWM Timer Compare Capture Register E	GTCCRE	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2A9Ah	GPT7	General PWM Timer Compare Capture Register F	GTCCRF	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2A9Ch	GPT7	General PWM Timer Cycle Setting Register	GTPR	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2A9Eh	GPT7	General PWM Timer Cycle Setting Buffer Register	GTPBR	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2AA0h	GPT7	General PWM Timer Cycle Setting Double-Buffer Register	GTPDBR	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2AA4h	GPT7	A/D Converter Start Request Timing Register A	GTADTRA	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.
000C 2AA6h	GPT7	A/D Converter Start Request Timing Buffer Register A	GTADTBRA	16	16, 32	2 to 5 PCLKA	2, 3 ICLK		Not present in versions with 64 or 48 pins.

Table 4.1 List of I/O Registers (Address Order) (48/48)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Module Name	Remarks
						ICLK $\geq$ PCLK	ICLK $<$ PCLK		
007F FFB0h	FLASH	Flash Status Register 0	FSTATR0	8	8	2, 3 FCLK	2, 3 ICLK	ROM	
007F FFB1h	FLASH	Flash Status Register 1	FSTATR1	8	8	2, 3 FCLK	2, 3 ICLK		
007F FFB2h	FLASH	Flash P/E Mode Entry Register	FENTRYR	16	16	2, 3 FCLK	2, 3 ICLK	ROM/ E2 DataFlash Memory	
007F FFB4h	FLASH	Flash Protection Register	FPROTR	16	16	2, 3 FCLK	2, 3 ICLK	ROM	
007F FFB6h	FLASH	Flash Reset Register	FRESETR	16	16	2, 3 FCLK	2, 3 ICLK		
007F FFBAh	FLASH	FCU Command Register	FCMDR	16	16	2, 3 FCLK	2, 3 ICLK		
007F FFC8h	FLASH	FCU Processing Switching Register	FCPSR	16	16	2, 3 FCLK	2, 3 ICLK		
007F FFCAh	FLASH	E2 DataFlash Blank Check Control Register	DFLBCCNT	16	16	2, 3 FCLK	2, 3 ICLK	E2 DataFlash Memory	
007F FFCh	FLASH	Flash P/E Status Register	FPESTAT	16	16	2, 3 FCLK	2, 3 ICLK	ROM	
007F FFCEh	FLASH	E2 DataFlash Blank Check Status Register	DFLBCSTAT	16	16	2, 3 FCLK	2, 3 ICLK	E2 DataFlash Memory	
007F FFE8h	FLASH	Peripheral Clock Notification Register	PCKAR	16	16	2, 3 FCLK	2, 3 ICLK	ROM	

Note: • This table shows the maximum specifications of I/O registers. The I/O registers of individual products correspond to the list of functions given as Table 1.2. For details, refer to Table 1.2, Comparison of Functions for Different Packages.

Note 1. When the register is accessed while the USB is operating, a delay may be generated in accessing.

Note 2. Odd addresses are not accessible in 16-bit units. Obtain 16-bit access to the two registers by access to the address of TMOCNLT.

Note 3. Pins USB0 and RIIC1 are not present in 112-pin products.

Note 4. Pins USB0, RIIC1, and SCI3 are not present in 100-pin products.

Note 5. Pins GPT4 to GPT7, USB0, RSP1, RIIC1, SCI2, SCI3, CAN1, AD, and S12AD1 are not present in 64- and 48-pin products.

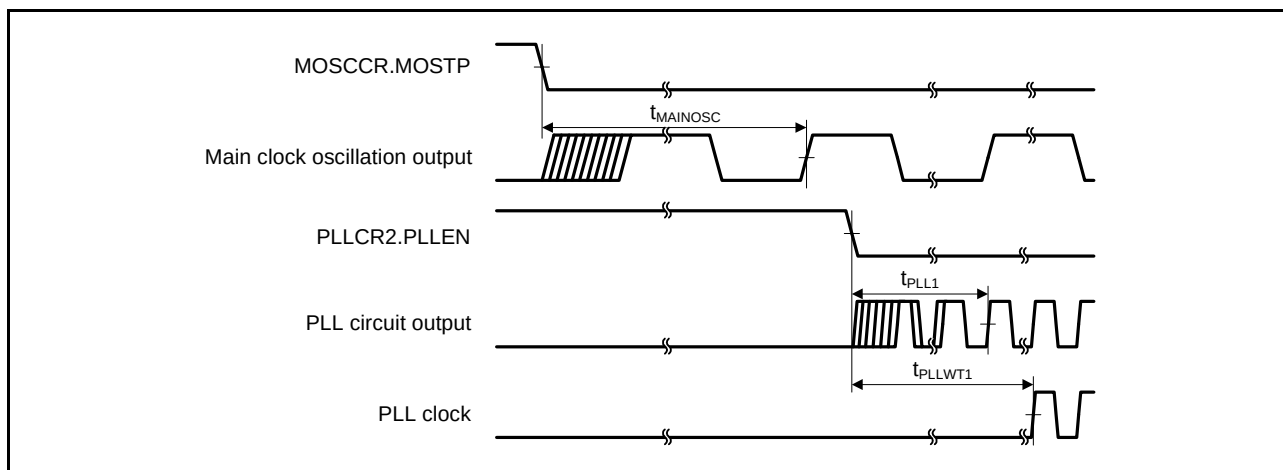


Figure 5.7 PLL Clock Oscillation Start Timing (PLL is Operated after Main Clock Oscillation Has Settled)

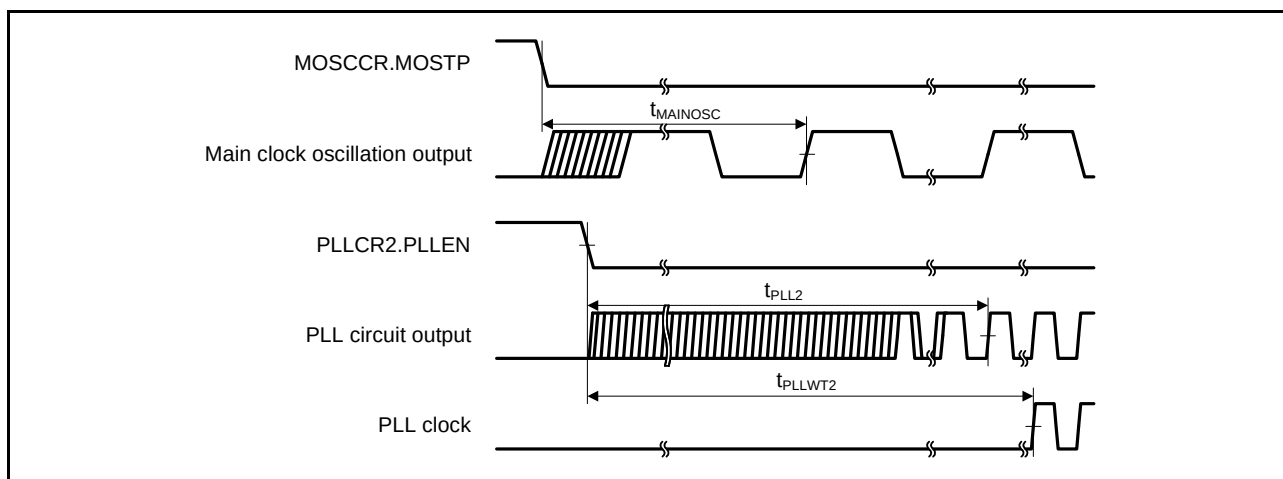


Figure 5.8 PLL Clock Oscillation Start Timing (PLL is Operated before Main Clock Oscillation Has Settled)

5.3.5 Bus Timing

Table 5.12 Bus Timing (1)

Condition: VCC = PLLVCC = VCC_USB = AVCC0 = AVCC = 3.0 to 3.6 V,

VSS = PLLVSS = VSS_USB = AVSS0 = AVSS = VREFL0 = 0 V

VREFH0 = 3.0 V to AVCC0, VREF = 3.0 V to AVCC

 $T_a = T_{opr}$ Output load conditions: $V_{OH} = VCC \times 0.5$, $V_{OL} = VCC \times 0.5$, $I_{OH} = -1.0$ mA, $I_{OL} = 1.0$ mA, $C = 30$ pF

Item	Symbol	Min.	Max.	Unit	Test Conditions
Address delay time	t_{AD}	—	30	ns	Figure 5.13 to Figure 5.16
Byte control delay time	t_{BCD}	—	30	ns	
CS# delay time	t_{CSD}	—	30	ns	
RD# delay time	t_{RSD}	—	30	ns	
Read data setup time	t_{RDS}	20	—	ns	
Read data hold time	t_{RDH}	0	—	ns	
WR# delay time	t_{WRD}	—	30	ns	
Write data delay time	t_{WDD}	—	35	ns	
Write data hold time	t_{WDH}	0	—	ns	
WAIT# setup time	t_{WTS}	20	—	ns	Figure 5.17
WAIT# hold time	t_{WTH}	0	—	ns	

Table 5.13 Bus Timing (2)

Condition: VCC = PLLVCC = AVCC0 = AVCC = 4.0 to 5.5 V, VCC_USB = 3.0 to 3.6 V,

VSS = PLLVSS = VSS_USB = AVSS0 = AVSS = VREFL0 = 0 V

VREFH0 = 4.0 V to AVCC0, VREF = 4.0 V to AVCC

 $T_a = T_{opr}$ Output load conditions: $V_{OH} = VCC \times 0.5$, $V_{OL} = VCC \times 0.5$, $I_{OH} = -1.0$ mA, $I_{OL} = 1.0$ mA, $C = 30$ pF

Item	Symbol	Min.	Max.	Unit	Test Conditions
Address delay time	t_{AD}	—	15	ns	Figure 5.13 to Figure 5.16
Byte control delay time	t_{BCD}	—	15	ns	
CS# delay time	t_{CSD}	—	15	ns	
RD# delay time	t_{RSD}	—	15	ns	
Read data setup time	t_{RDS}	15	—	ns	
Read data hold time	t_{RDH}	0	—	ns	
WR# delay time	t_{WRD}	—	15	ns	
Write data delay time	t_{WDD}	—	15	ns	
Write data hold time	t_{WDH}	0	—	ns	
WAIT# setup time	t_{WTS}	15	—	ns	Figure 5.17
WAIT# hold time	t_{WTH}	0	—	ns	

Table 5.16 Timing of On-Chip Peripheral Modules (3)

Note: Common standard values for conditions not given in the table are listed as “Condition 1” to “Condition 3” below.

Condition 1: VCC = PLLVCC = VCC_USB = 2.7 to 3.6 V, VSS = PLLVSS = VSS_USB = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = VREF = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0

Condition 2: VCC = PLLVCC = VCC_USB = 2.7 to 3.6 V, VSS = PLLVSS = VSS_USB = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = VREF = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VCC_USB = 3.0 to 3.6 V, VSS = PLLVSS = VSS_USB = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = VREF = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0

$T_a = T_{opr}$ T_a is common to conditions 1 to 3.

High drive output is selected by the drive capacity control register.

Item				Symbol	Min.	Max.	Unit*1	Test Conditions	
RSPI	RSPCK clock cycle	Master		t_{SPcyc}	2	4096	t_{Pcyc}	C = 30 pF, Figure 5.32	
		Slave			8	4096			
	RSPCK clock high pulse width	Master		t_{SPCKWH}	$(t_{SPcyc} - t_{SPCKR} - t_{SPCKF}) / 2 - 3$	—	ns		
		Slave			$(t_{SPcyc} - t_{SPCKR} - t_{SPCKF}) / 2$	—			
	RSPCK clock low pulse width	Master		t_{SPCKWL}	$(t_{SPcyc} - t_{SPCKR} - t_{SPCKF}) / 2 - 3$	—	ns		
		Slave			$(t_{SPcyc} - t_{SPCKR} - t_{SPCKF}) / 2$	—			
	RSPCK clock rise/fall time	Output		t_{SPCKR}, t_{SPCKF}	—	5	ns		
		Input			—	1	μs		
	RSPCK clock fall time	Input		t_{SPCKF}	—	0.1	μs/V		
	Data input setup time	Master		t_{SU}	4	—	ns		C = 30 pF, Figure 5.33 to Figure 5.40
		Slave			$20 - t_{Pcyc}$	—			
	Data input hold time	Master	PCLKB division ratio set to a value other than 1/2	t_H	t_{Pcyc}	—	ns		
		Slave		t_H	$20 + 2 \times t_{Pcyc}$	—			
SSL setup time		Master		t_{LEAD}	1	8		t_{SPcyc}	
	Slave		4		—	t_{Pcyc}			
SSL hold time	Master		t_{LAG}	1	8	t_{SPcyc}			
	Slave			4	—	t_{Pcyc}			
Data output delay time	Master		t_{OD}	—	10	ns			
	Slave			—	$3 \times t_{Pcyc} + 40$				
Data output hold time	Master		t_{OH}	0	—	ns			
	Slave			0	—				
Successive transmission delay time	Master		t_{TD}	$t_{SPcyc} + 2 \times t_{Pcyc}$	$8 \times t_{SPcyc} + 2 \times t_{Pcyc}$	ns			
	Slave			$4 \times t_{Pcyc}$	—				
MOSI and MISO rise/fall time	Output		t_{DR}, t_{DF}	—	5	ns			
	Input			—	1	μs			
SSL rise/fall time	Output		t_{SSLr}, t_{SSLf}	—	15	ns			
	Input			—	1	μs			
Slave access time				t_{SA}	—	4	t_{Pcyc}	Figure 5.39 and Figure 5.40	
Slave output release time				t_{REL}	—	3	t_{Pcyc}		

Note 1. t_{Pcyc} : PCLK cycle

Table 5.16 Timing of On-Chip Peripheral Modules (5)

Note: Common standard values for conditions not given in the table are listed as “Condition 1” to “Condition 3” below.

Condition 1: VCC = PLLVCC = VCC_USB = 2.7 to 3.6 V, VSS = PLLVSS = VSS_USB = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = VREF = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0

Condition 2: VCC = PLLVCC = VCC_USB = 2.7 to 3.6 V, VSS = PLLVSS = VSS_USB = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = VREF = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VCC_USB = 3.0 to 3.6 V, VSS = PLLVSS = VSS_USB = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = VREF = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0

$T_a = T_{opr}$ T_a is common to conditions 1 to 3.

Item		Symbol	Min.*1,*2	Max.	Unit	Test Conditions
RIIC (Standard-mode)	SCL input cycle time	t_{SCL}	$6(12) \times t_{IICcyc} + 1300$	—	ns	Figure 5.36
	SCL input high pulse width	t_{SCLH}	$3(6) \times t_{IICcyc} + 300$	—	ns	
	SCL input low pulse width	t_{SCLL}	$3(6) \times t_{IICcyc} + 300$	—	ns	
	SCL, SDA input rise time	t_{Sr}	—	1000	ns	
	SCL, SDA input fall time	t_{Sf}	—	300	ns	
	SCL, SDA input spike pulse removal time	t_{SP}	0	$1(4) \times t_{IICcyc}$	ns	
	SDA input bus free time	t_{BUF}	$3(6) \times t_{IICcyc} + 300$	—	ns	
	Start condition input hold time	t_{STAH}	$t_{IICcyc} + 300$	—	ns	
	Restart condition input setup time	t_{STAS}	1000	—	ns	
	Stop condition input setup time	t_{STOS}	1000	—	ns	
	Data input setup time	t_{SDAS}	$t_{IICcyc} + 50$	—	ns	
	Data input hold time	t_{SDAH}	0	—	ns	
	SCL, SDA capacitive load	C_b	—	400	pF	
RIIC (Fast-mode)	SCL input cycle time	t_{SCL}	$6(12) \times t_{IICcyc} + 600$	—	ns	
	SCL input high pulse width	t_{SCLH}	$3(6) \times t_{IICcyc} + 300$	—	ns	
	SCL input low pulse width	t_{SCLL}	$3(6) \times t_{IICcyc} + 300$	—	ns	
	SCL, SDA input rise time	t_{Sr}	$20 + 0.1C_b$	300	ns	
	SCL, SDA input fall time	t_{Sf}	$20 + 0.1C_b$	300	ns	
	SCL, SDA input spike pulse removal time	t_{SP}	0	$1(4) \times t_{IICcyc}$	ns	
	SDA input bus free time	t_{BUF}	$3(6) \times t_{IICcyc} + 300$	—	ns	
	Start condition input hold time	t_{STAH}	$t_{IICcyc} + 300$	—	ns	
	Restart condition input setup time	t_{STAS}	300	—	ns	
	Stop condition input setup time	t_{STOS}	300	—	ns	
	Data input setup time	t_{SDAS}	$t_{IICcyc} + 50$	—	ns	
	Data input hold time	t_{SDAH}	0	—	ns	
	SCL, SDA capacitive load	C_b	—	400	pF	

Note: • t_{IICcyc} : RIIC internal reference clock (IIC ϕ) cycle

Note 1. The value within parentheses is applicable when the value of the ICMR3.NF[1:0] bits is 11b while the digital filter is enabled by the setting ICFER.NFE = 1.

Note 2. C_b is the total capacitance of the bus lines.

5.5 A/D Conversion Characteristics

Table 5.19 10-Bit A/D Conversion Characteristics (1)

Note: Common standard values for conditions not given in the table are listed as “Condition 1” to “Condition 3” below.

Condition 1: VCC = PLLVCC = VCC_USB = 2.7 to 3.6 V, VSS = PLLVSS = VSS_USB = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = VREF = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0

Condition 2: VCC = PLLVCC = VCC_USB = 2.7 to 3.6 V, VSS = PLLVSS = VSS_USB = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = VREF = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0

Condition 3: VCC = PLLVCC = 4.0 to 5.5 V, VCC_USB = 3.0 to 3.6 V, VSS = PLLVSS = VSS_USB = AVSS0 = AVSS = VREFL0 = 0 V
AVCC0 = AVCC = VREF = 4.0 to 5.5 V, VREFH0 = 4.0 V to AVCC0

T_a = T_{opr}. T_a is common to conditions 1 to 3.

Item			Min.	Typ.	Max.	Unit	Test Conditions
Resolution			10	10	10	Bit	
Conversion time*1 (Operation at ADCLK = 100 MHz)	With 0.1-μF external capacitor	AN0 to AN7	0.5	—	—	μs	Sampling in 25 states
		Other channels	0.75	—	—	μs	Sampling in 50 states
	Without 0.1-μF external capacitor Permissible signal source impedance (max.) = 1 kΩ	AN0 to AN7	0.6	—	—	μs	Sampling in 35 states
		Other channels	0.75	—	—	μs	Sampling in 50 states
Analog input capacitance			—	—	6	pF	
Integral nonlinearity error			—	—	±3.0	LSB	
Offset error			—	—	±2.0	LSB	
Full-scale error			—	—	±3.0	LSB	
Quantization error			—	±0.5	—	LSB	
Absolute accuracy			—	—	±6.0	LSB	

Note 1. The conversion time includes the sampling time and the comparison time. As the test conditions, the number of sampling states is indicated.

6.3 AC Characteristics

Table 6.6 Operation Frequency Value

Conditions: VCC = 2.7 to 3.6 V, VSS = AVSS0 = VREFL0 = 0 V,
AVCC0 = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0,
Ta = T_{opr}

Item		Symbol	Min.	Typ	Max.	Unit
Operation frequency	System clock (ICLK)	f	—	—	100	MHz
	Peripheral module clock PCLK		—	—	50	
	Timer module clock (PCLKA)		—	—	100	
	S12AD clock (PCLKD)		—	—	50	
	Flash clock (FCLK)		—*1	—	50	

Note 1. The FCLK must run at a frequency of at least 4 MHz when changing the ROM or E2 DataFlash memory contents.

6.3.1 Clock Timing

Table 6.7 Clock Timing

Conditions: VCC = 2.7 to 3.6 V, VSS = AVSS0 = VREFL0 = 0 V,
AVCC0 = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0,
Ta = T_{opr}

Item		Symbol	Min	Typ	Max.	Unit	Test Conditions
EXTAL external clock input cycle time		t _{EXcyc}	50	—	—	ns	Figure 6.1
EXTAL external clock input high pulse width		t _{EXH}	20	—	—	ns	
EXTAL external clock input low pulse width		t _{EXL}	20	—	—	ns	
EXTAL external clock rising time		t _{EXr}	—	—	5	ns	
EXTAL external clock falling time		t _{EXf}	—	—	5	ns	
EXTAL external clock input wait time*1		t _{EXWT}	1	—	—	ms	
Main clock oscillator oscillation frequency		f _{MAIN}	4	—	16	MHz	
Main clock oscillator stabilization time (crystal)		t _{MAINOSC}	—	—	—*2	ms	Figure 6.2
Main clock oscillator stabilization wait time (crystal)		t _{MAINOSCW}	—	—	—*3	ms	
LOCO, IWDTCCLK clock cycle time		t _{cyc}	6.96	8	9.4	μs	
LOCO, IWDTCCLK clock oscillation frequency		f _{LOCO}	106.25	125	143.75	kHz	
LOCO, IWDTCCLK clock oscillation stabilization wait time		t _{LOCOWT}	—	—	20	μs	Figure 6.2
PLL clock oscillation stabilization time	PLL operation started after main clock oscillation has settled	t _{PLL1}	—	—	500	μs	Figure 6.4
PLL clock oscillation stabilization wait time		t _{PLLWT1}	—	—	—*4	ms	
PLL clock oscillation stabilization time PLL	PLL operation started before main clock oscillation has settled	t _{PLL2}	—	—	t _{MAINOSC} + t _{PLL1}	ms	Figure 6.5
PLL clock oscillation stabilization wait time		t _{PLLWT2}	—	—	—*4	ms	

Note 1. This is the time until the clock is used after clearing the main clock oscillator stop bit (MOSCCR.MOSTP) to 0 (selecting operation).

Note 2. When using a main clock, ask the manufacturer of the oscillator to evaluate its oscillation. Refer to the results of evaluation provided by the manufacturer for the oscillation stabilization time.

Note 3. This is calculated from the formula below, where n is the number of cycles set by the MOSCWTCR.MSTS[4:0] bits.

$$t_{\text{MAINOSCW}} = t_{\text{MAINOSC}} + \frac{n + 16384}{f_{\text{MAIN}}}$$

6.3.3 Timing of Recovery from Low Power Consumption Modes

Table 6.9 Timing of Recovery from Low Power Consumption Modes

Conditions: $V_{CC} = 2.7$ to 3.6 V, $V_{SS} = AV_{SS0} = V_{REFL0} = 0$ V,
 $AV_{CC0} = 3.0$ to 3.6 V, $V_{REFH0} = 3.0$ V to AV_{CC0} ,
 $T_a = T_{opr}$

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Recovery time after cancellation of software standby mode	Crystal resonator connected to main clock oscillator operating	t_{SBYMC}	10	—	—	ms
	Main clock oscillator and PLL circuit operating	t_{SBYPC}	10	—	—	ms
	External clock input to main clock oscillator operating	t_{SBYEX}	1	—	—	ms
	Main clock oscillator and PLL circuit operating	t_{SBYPE}	1	—	—	ms
	Low-speed clock oscillator or IWDG-specific low-speed clock oscillator operating	t_{SBYLO}	—	—	800	μ s
Recovery time after cancellation of deep software standby mode	t_{DSBY}	—	—	1	ms	Figure 6.9
Wait time after cancellation of deep software standby mode	t_{DSBYWT}	45	—	46	t_{cyc}	

Note: • The wait time varies depending on the state in which each oscillator was when the WAIT instruction was executed. The recovery time when multiple oscillators are operating is the same period as that when the oscillator, which takes the longest time for recovery among the operating oscillators, is operating alone.

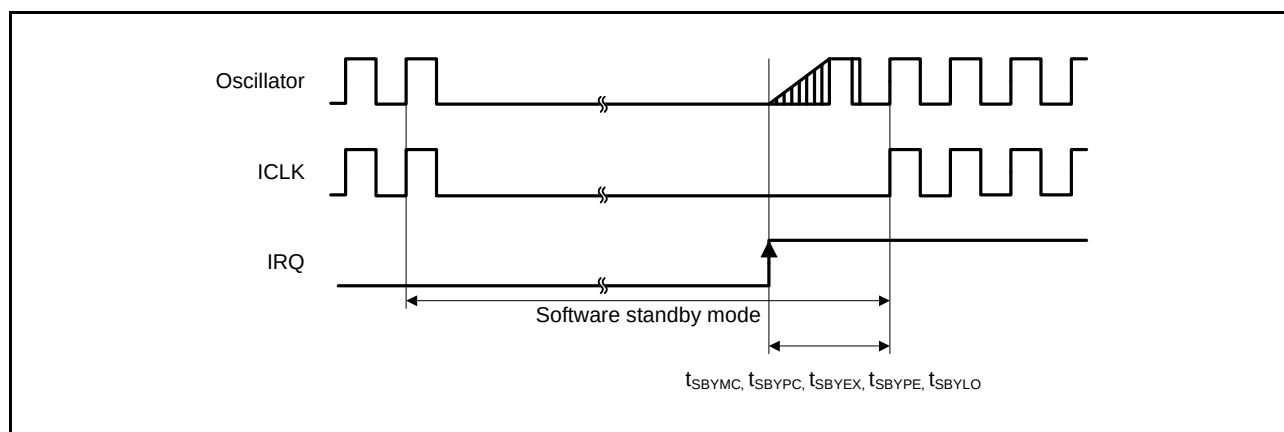


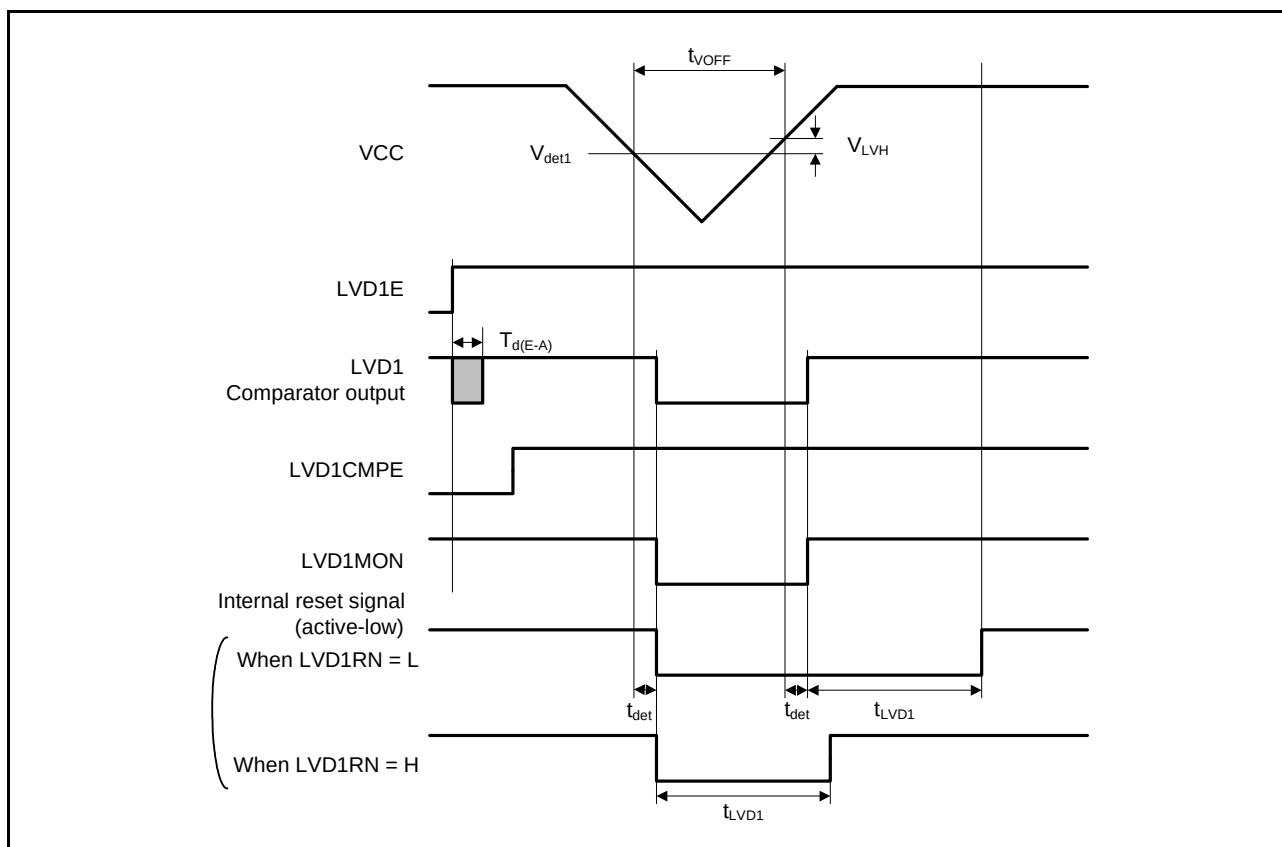
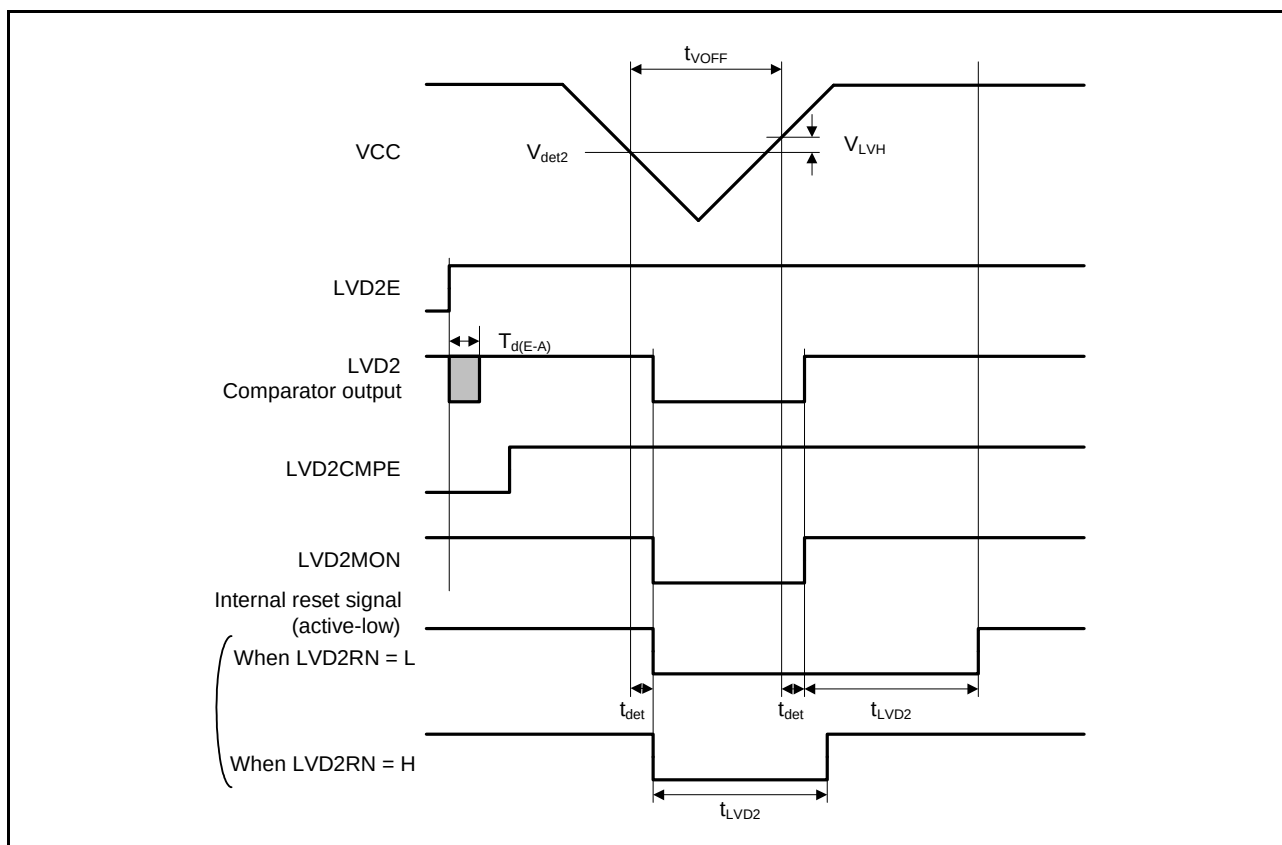
Figure 6.8 Software Standby Mode Cancellation Timing

Table 6.12 Timing of On-Chip Peripheral Modules (2)

Conditions: VCC = 2.7 to 3.6 V, VSS = AVSS0 = VREFL0 = 0 V,
 AVCC0 = 3.0 to 3.6 V, VREFH0 = 3.0 V to AVCC0,
 Ta = T_{opr}

Item			Symbol	Min.	Max.	Unit*1	Test Conditions
RSPI	RSPCK clock cycle	Master	t _{SPcyc}	2	4096	t _{Pcyc}	Figure 6.20
		Slave		8	4096		
	RSPCK clock high pulse width	Master	t _{SPCKWH}	(t _{SPcyc} – t _{SPCKR} – t _{SPCKF}) / 2 – 3	—	ns	
		Slave		(t _{SPcyc} – t _{SPCKR} – t _{SPCKF}) / 2	—		
	RSPCK clock low pulse width	Master	t _{SPCKWL}	(t _{SPcyc} – t _{SPCKR} – t _{SPCKF}) / 2 – 3	—	ns	
		Slave		(t _{SPcyc} – t _{SPCKR} – t _{SPCKF}) / 2	—		
	RSPCK clock rise/fall time	Output	t _{SPCKR} , t _{SPCKF}	—	5	ns	
		Input		—	1	μs	
	Data input setup time	Master	t _{SU}	15	—	ns	Figure 6.21 to Figure 6.24
				20	—		
		Slave		20 – t _{Pcyc}	—		
	Data input hold time	Master	t _H	0	—	ns	
		Slave		20 + 2 × t _{Pcyc}	—		
	SSL setup time	Master	t _{LEAD}	1	8	t _{SPcyc}	
		Slave		4	—	t _{Pcyc}	
	SSL hold time	Master	t _{LAG}	1	8	t _{SPcyc}	
		Slave		4	—	t _{Pcyc}	
	Data output delay time	Master	t _{OD}	—	18	ns	
		Slave		—	3 × t _{Pcyc} + 40		
	Data output hold time	Master	t _{OH}	0	—	ns	
		Slave		0	—		
Successive transmission delay time	Master	t _{TD}	t _{SPcyc} + 2 × t _{Pcyc}	8 × t _{SPcyc} + 2 × t _{Pcyc}	ns		
	Slave		4 × t _{Pcyc}	—			
MOSI rise/fall time	Output	t _{MODR} , t _{MODF}	—	5	ns		
	Input		—	1	μs		
MISO rise/fall time	Output	t _{MODR} , t _{MODF}	—	5	ns		
	Input		—	1	μs		
SSL rise/fall time	Output	t _{SSLr} , t _{SSLf}	—	15	ns		
	Input		—	1	μs		
Slave access time			t _{SA}	—	4	t _{Pcyc}	Figure 6.23 and Figure 6.24
Slave output release time			t _{REL}	—	3	t _{Pcyc}	

Note 1. t_{PCyc}: PCLK cycle

Figure 6.28 Voltage Detection Circuit Timing (V_{det1})Figure 6.29 Voltage Detection Circuit Timing (V_{det2})